TOSHIBA Field-Effect Transistor Silicon N-Channel MOS Type

# SSM6K407TU

 DC-DC Converter, Relay Drive and Motor Drive Applications

- 4V drive
- Low ON-resistance :  $R_{on} = 440m\Omega (max) (@V_{GS} = 4 V)$

:  $R_{on} = 300m\Omega$  (max) (@V<sub>GS</sub> = 10 V)

Symbol

### 2.1±0.1 1.7±0.1 0.65 +0.1 0.3-0.05 2.0±0.1 1.3±0.1 0.65 0.166±0.05 05 0.7±0.0 1,2,5,6 : Drain : Gate 3 UF6 : Source 4 JEDEC JEITA TOSHIBA 2-2T1D

### Absolute Maximum Ratings (Ta = 25°C) (Note)

Characteristic

| Drain-source voltage    |                 | 60                                  | V  |  |
|-------------------------|-----------------|-------------------------------------|--|--|
| Gate-source voltage     |                 | ±20                                 | V  |  |
| DC                      | ۱ <sub>D</sub>  | 2                                   | A  |  |
| Pulse                   | I <sub>DP</sub> | 6                                   |  |  |
| Drain power dissipation |                 | 500                                 | mW   |  |
|                         | T <sub>ch</sub> | 150                                 | °C   |  |
| Storage temperature     |                 | -55 to 150                          | °C   |  |
|                         |                 | Pulse I <sub>DP</sub><br>PD (Note1) | VGSS         ±20           DC         ID         2           Pulse         IDP         6           PD         Note1)         500           Tch         150         150 |  |

Weight: 7mg (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Rating

Unit

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on an FR4 board (25.4 mm  $\times$  25.4 mm  $\times$  1.6 t, Cu Pad: 645 mm<sup>2</sup>)

Unit: mm

Electrical Characteristics (Ta = 25°C)

| Characteristic                        |               | Symbol               | Test Condition   | Min | Тур. | Max  | Unit |
|---------------------------------------|---------------|----------------------|--|-----|------|------|------|
| Gate leakage current I <sub>GSS</sub> |               | IGSS                 | $V_{GS}$ = ±16 V, $V_{DS}$ = 0 V                         | _   | _    | ±10  | μA   |
| Drain cutoff currer                   | t             | I <sub>DSS</sub>     | V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V            | _   | _    | 100  | μA   |
| Drain-source brea                     | kdown voltage | V (BR) DSS           | I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V            | 60  | _    | _    | V    |
| Gate threshold vol                    | tage          | V <sub>th</sub>      | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA            | 0.8 | _    | 2.0  | V    |
| Drain–source ON-resistance            |               | D                    | V <sub>GS</sub> = 4 V, I <sub>D</sub> = 1 A (Note2)      | _   | 0.33 | 0.44 | Ω    |
|                                       |               | R <sub>DS (ON)</sub> | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1 A (Note2)     | _   | 0.22 | 0.30 |      |
| Forward transfer a                    | dmittance     | Y <sub>fs</sub>      | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 A (Note2)     | 1.0 | 2.0  | _    | S    |
| Input capacitance                     |               | C <sub>iss</sub>     |  | _   | 150  | _    | pF   |
| Reverse transfer capacitance          |               | C <sub>rss</sub>     | V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz | _   | 25   | _    |      |
| Output capacitance                    |               | C <sub>oss</sub>     | -  | _   | 70   | _    |      |
| Switching time                        | Turn-on time  | t <sub>on</sub>      | V <sub>DD</sub> = 30 V, I <sub>D</sub> = 1 A             | _   | 30   | _    | 20   |
|                                       | Turn-off time | t <sub>off</sub>     | $V_{GS}$ = 0 to 10 V, $R_{G}$ = 50 $\Omega$              | _   | 150  | _    | ns   |
| Total Gate Charge                     |               | Qg                   |  | _   | 6.0  | _    | nC   |
| Gate-Source Charge                    |               | Q <sub>gs</sub>      | $V_{DD}$ = 48 V, $V_{GS}$ = 10 V, $I_D$ = 2 A            | _   | 4.6  | -    |      |
| Gate-Drain Charge                     |               | Q <sub>gd</sub>      |  | _   | 1.4  | -    |      |
| Drain-source forward voltage          |               | V <sub>DSF</sub>     | $I_D = -2 \text{ A}, V_{GS} = 0 \text{ V}$ (Note2)       | —   | -1.0 | -1.5 | V    |

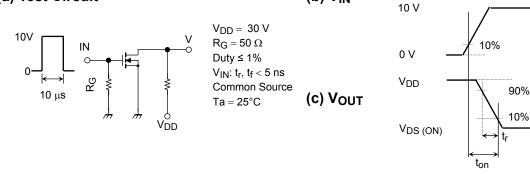
Note 2: Pulse test

90%

t<sub>off</sub>

### **Switching Time Test Circuit**

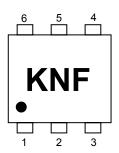
### (a) Test Circuit



(b) V<sub>IN</sub>

### Marking

### Equivalent Circuit (top view)



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### Notice on Usage

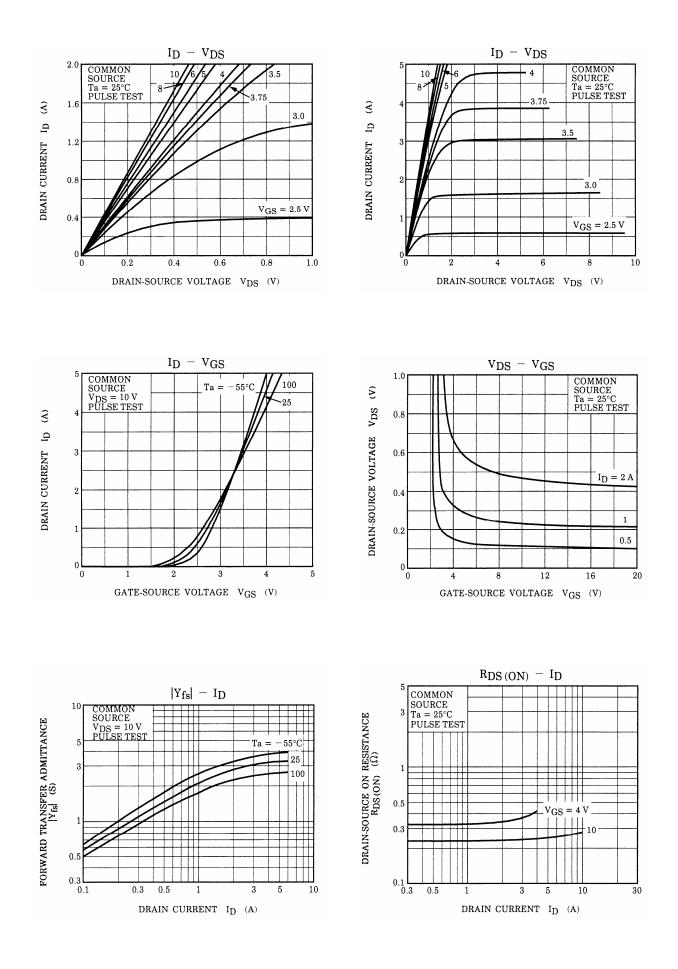
 $V_{th}$  can be expressed as the voltage between gate and source when the low operating current value is  $I_D = 1$  mA for this product. For normal switching operation,  $V_{GS (on)}$  requires a higher voltage than  $V_{th}$  and  $V_{GS (off)}$  requires a lower voltage than  $V_{th}$ . (The relationship can be established as follows:  $V_{GS (off)} < V_{th} < V_{GS (on)}$ .)

Take this into consideration when using the device.

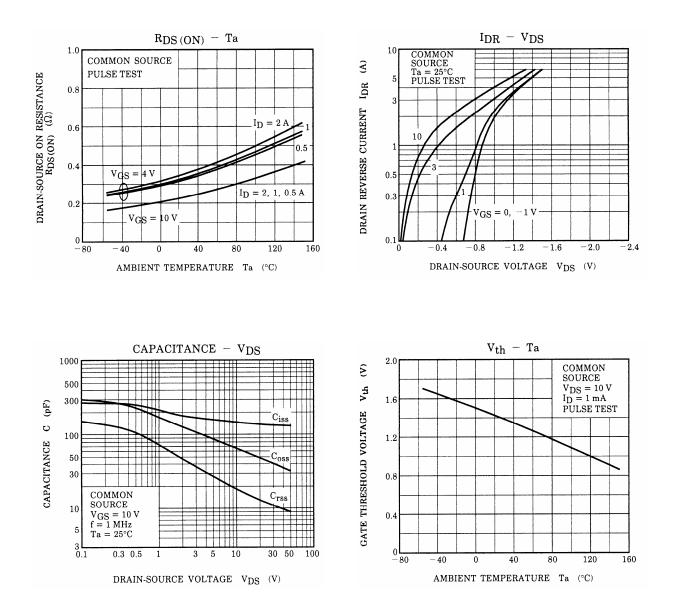
### **Handling Precaution**

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

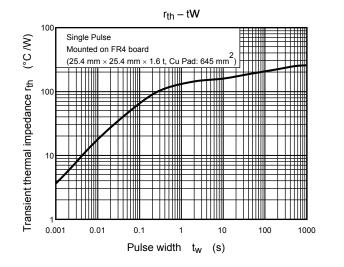
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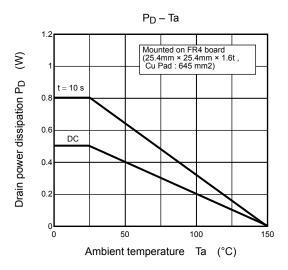


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